# Silicon P Channel DV–L MOS FET High Speed Power Switching

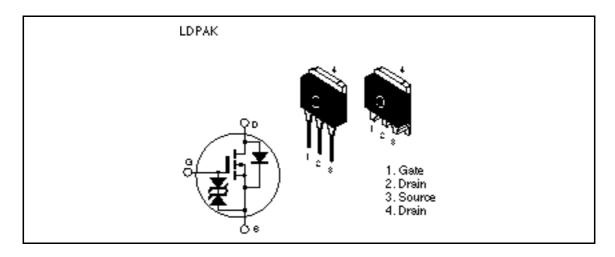
# HITACHI

ADE-208-541 1st. Edition

#### **Features**

- Low on-resistance  $R_{DS(on)} = 25 \ m \quad typ. \label{eq:RDS(on)}$
- 4V gate drive devices.
- · High speed switching

#### **Outline**





#### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{ t DSS}$	-30	V
Gate to source voltage	$V_{GSS}$	±20	V
Drain current	I <sub>D</sub>	-30	A
Drain peak current	Note1 D(pulse)	-120	A
Body to drain diode reverse drain current	I <sub>DR</sub>	-30	A
Channel dissipation	Pch Note2	50	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW 10 µs, duty cycle 1 %

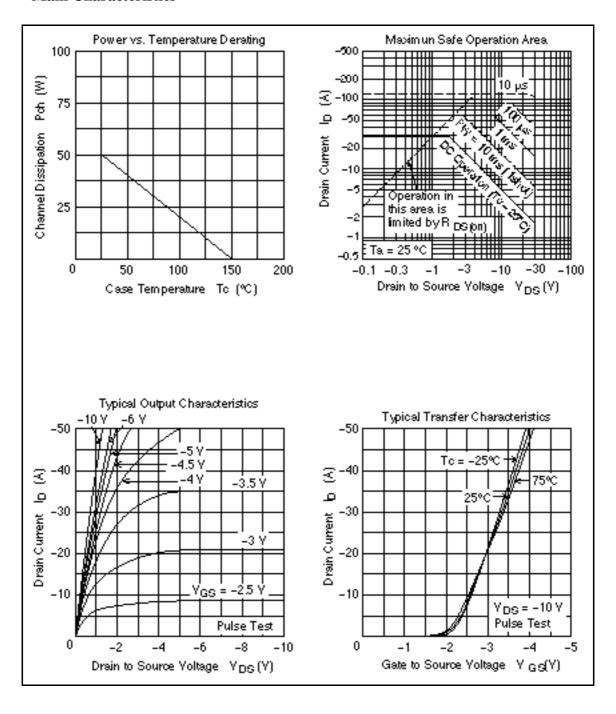
2. Value at Tc = 25°C

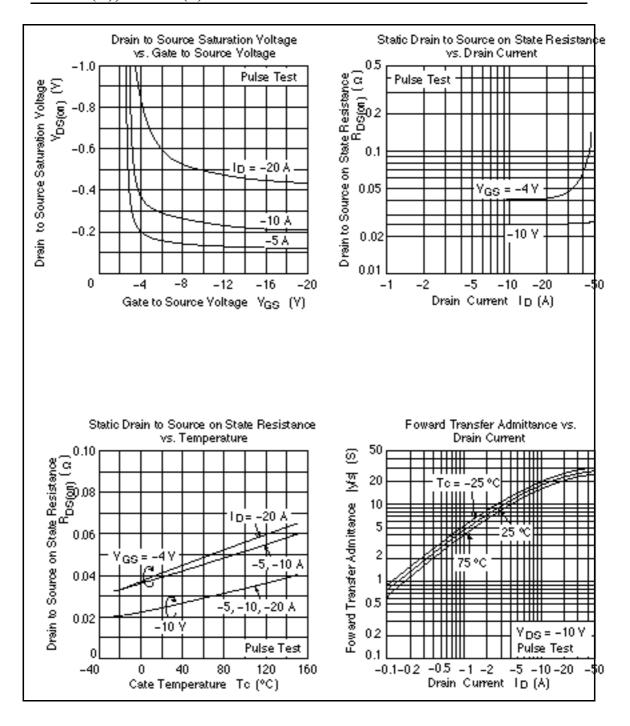
#### **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

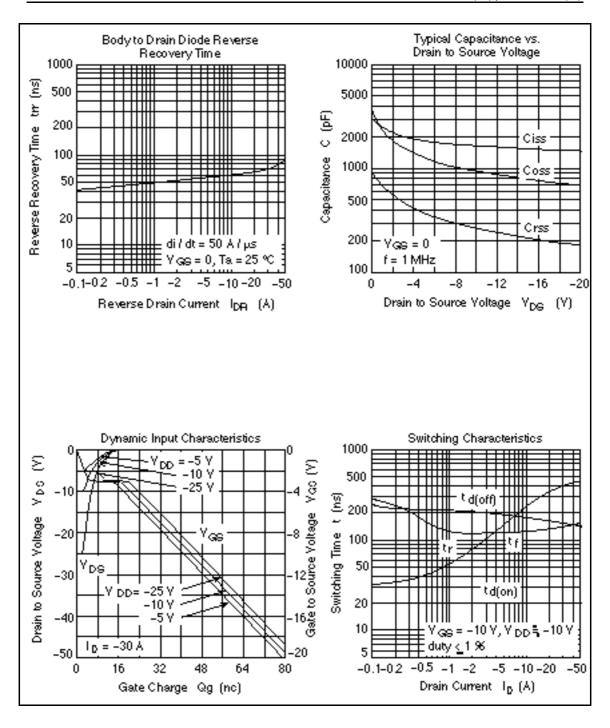
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	-30	_	_	V	$I_{D} = -10 \text{mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_{G} = \pm 100 \mu A, V_{DS} = 0$
Zero gate voltege drain current	I <sub>DSS</sub>	_	_	-10	μΑ	$V_{DS} = -30 \text{ V}, V_{GS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 16V, V_{DS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	-1.0	_	-2.0	V	$I_{D} = -1 \text{mA}, V_{DS} = -10 \text{V}$
Static drain to source on state	$R_{\text{DS(on)}}$	_	25	35	m	$I_{\rm D} = -15 A, \ V_{\rm GS} = -10 V^{\rm Note3}$
resistance	R <sub>DS(on)</sub>	_	40	60	m	$I_D = -15A, V_{GS} = -4V^{Note3}$
Forward transfer admittance	y <sub>fs</sub>	12	20	_	S	$I_{\rm D} = -15 A, V_{\rm DS} = -10 V^{\rm Note3}$
Input capacitance	Ciss	_	1700	_	pF	V <sub>DS</sub> = -10V
Output capacitance	Coss	_	950		pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	260	_	pF	f = 1MHz
Turn-on delay time	t <sub>d(on)</sub>	_	20	_	ns	$V_{GS} = -10V, I_{D} = -15A$
Rise time	t <sub>r</sub>	_	290	_	ns	$R_{L} = 0.67$
Turn-off delay time	$t_{d(off)}$	_	170	_	ns	_
Fall time	t <sub>f</sub>	_	130	_	ns	_
Body to drain diode forward voltage	$V_{DF}$	_	-1.1	_	V	$I_F = -30A, V_{GS} = 0$
Body to drain diode reverse recovery time	t <sub>rr</sub>	_	70	_	ns	$I_F = -30A, V_{GS} = 0$ diF/ dt = 50A/µs

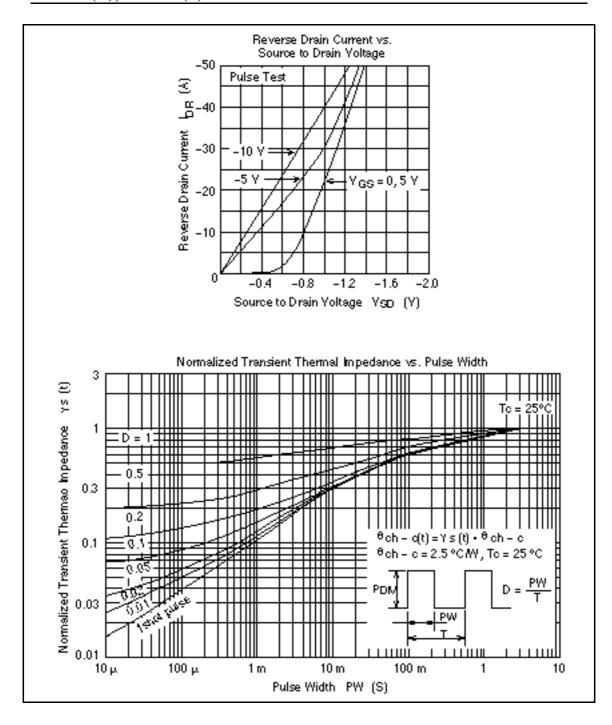
Note: 3. Pulse test

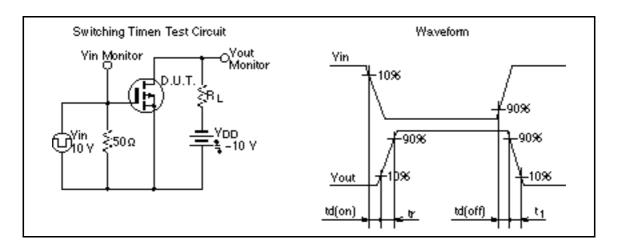
#### **Main Characteristics**





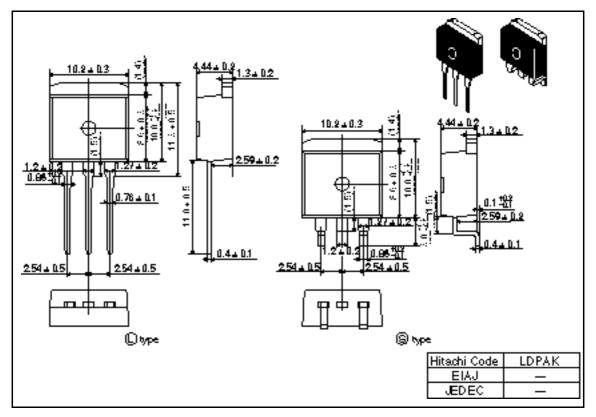






#### **Package Dimensions**

Unit: mm



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